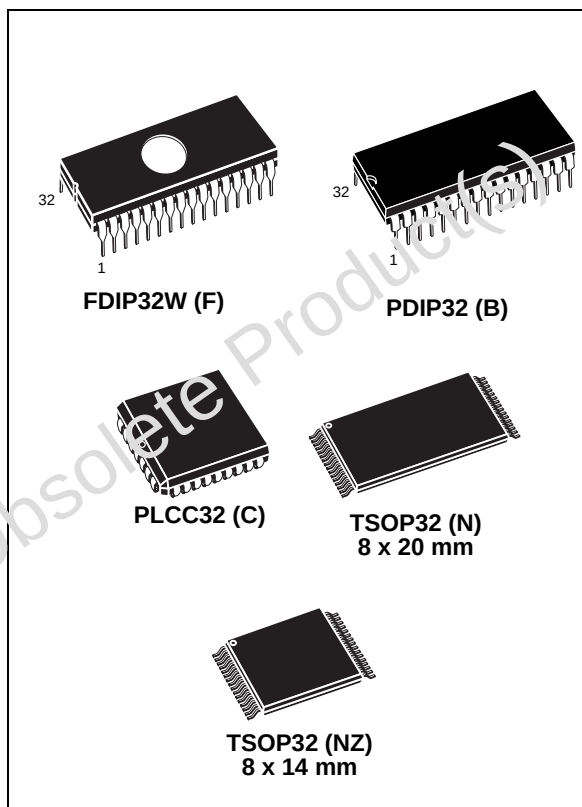


2 Mbit (256Kb x 8) Low Voltage UV EPROM and OTP EPROM

Features

- 2.7V to 3.6V Low Voltage in Read Operation
- Access Time:
 - 70 ns at $V_{CC} = 3.0V$ to 3.6V
 - 80 ns at $V_{CC} = 2.7V$ to 3.6V
- Pin Compatible with M27C2001
- Low Power Consumption:
 - 15 μA Max. Standby Current
 - 15 mA Max. Active Current at 5 MHz
- Programming Time: 100 μs /byte
- High Reliability CMOS Technology
 - 2,000V ESD Protection
 - 200 mA Latch-up Protection Immunity
- Electronic Signature
 - Manufacturer Code: 20h
 - Device Code: 61h
- ECOPACK® packages available



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1 Summary description

The M27W201 is a low voltage 2 Mbit EPROM offered in the two range UV (ultra violet erase) and OTP (one time programmable). It is ideally suited for microprocessor systems requiring large data or program storage and is organised as 262,144 by 8 bits.

The M27W201 operates in the read mode with a supply voltage as low as 2.7V at –40 to 85°C temperature range. The decrease in operating power allows either a reduction of the size of the battery or an increase in the time between battery recharges.

The FDIP32W (window ceramic frit-seal package) has a transparent lid which allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written to the device by following the programming procedure.

For application where the content is programmed only one time and erasure is not required, the M27W201 is offered in PDIP32, PLCC32 and TSOP32 (8 x 20mm and 8 x 14mm) packages.

In order to meet environmental requirements, ST offers the M27W201 in ECOPACK® packages. ECOPACK packages are Lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label.

ECOPACK is an ST trademark. ECOPACK® specifications are available at: www.st.com.

See [Figure 1: Logic Diagram](#) and [Table 1: Signal Descriptions](#) for a brief overview of the signals connected to this device.

Figure 1. Logic Diagram

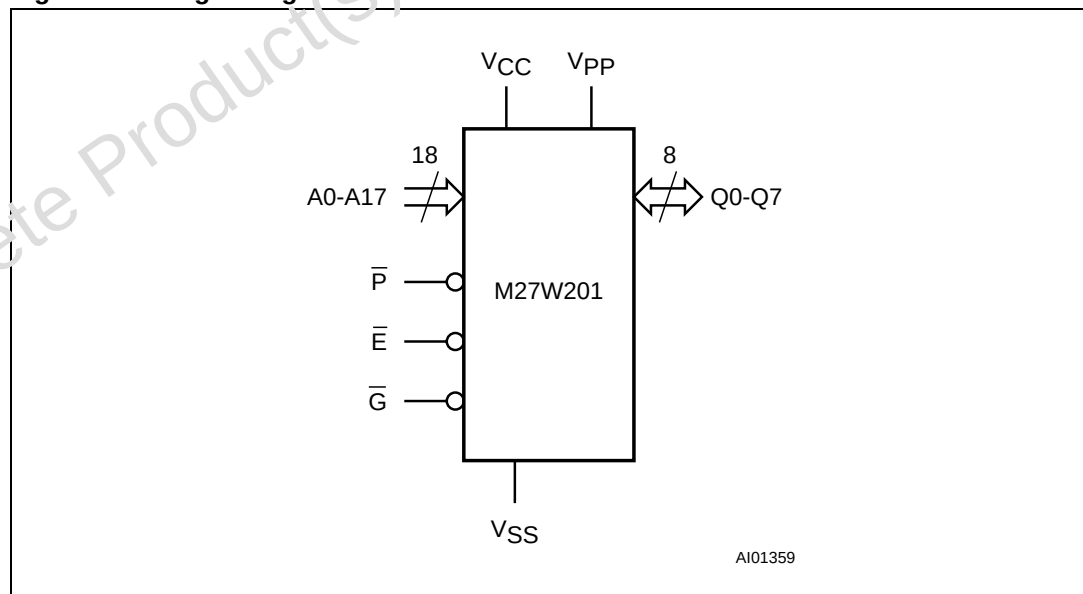


Table 1. Signal Descriptions

Signal	Description
A0-A17	Address Inputs
Q0-Q7	Data Outputs
$\overline{E}$	Chip Enable
$\overline{G}$	Output Enable
$\overline{P}$	Program
V _{PP}	Program Supply
V _{CC}	Supply Voltage
V _{SS}	Ground

Figure 2. DIP Connections

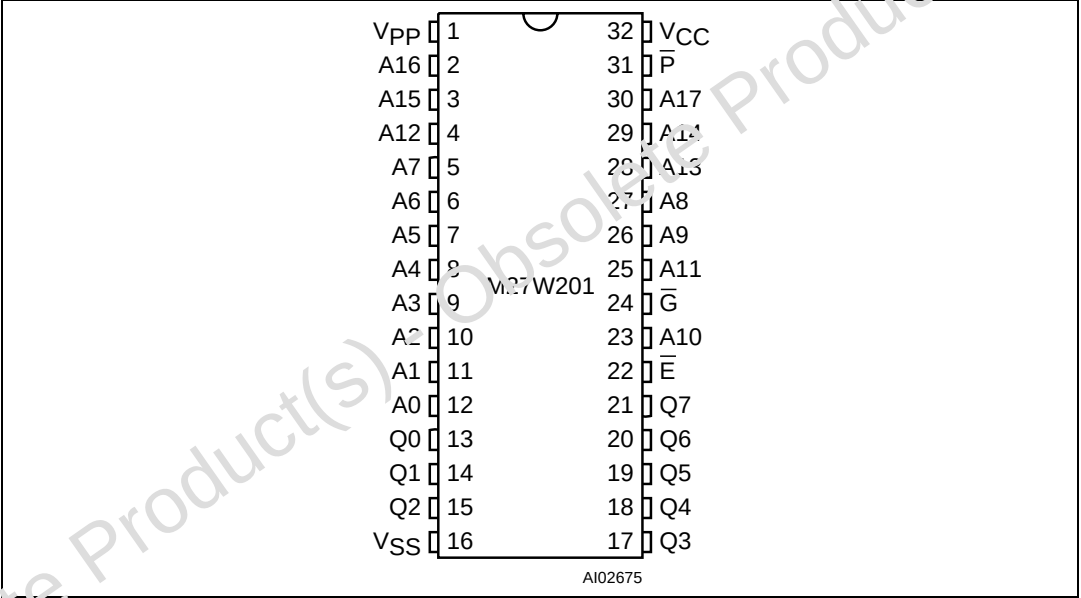


Figure 3. LCC Connections

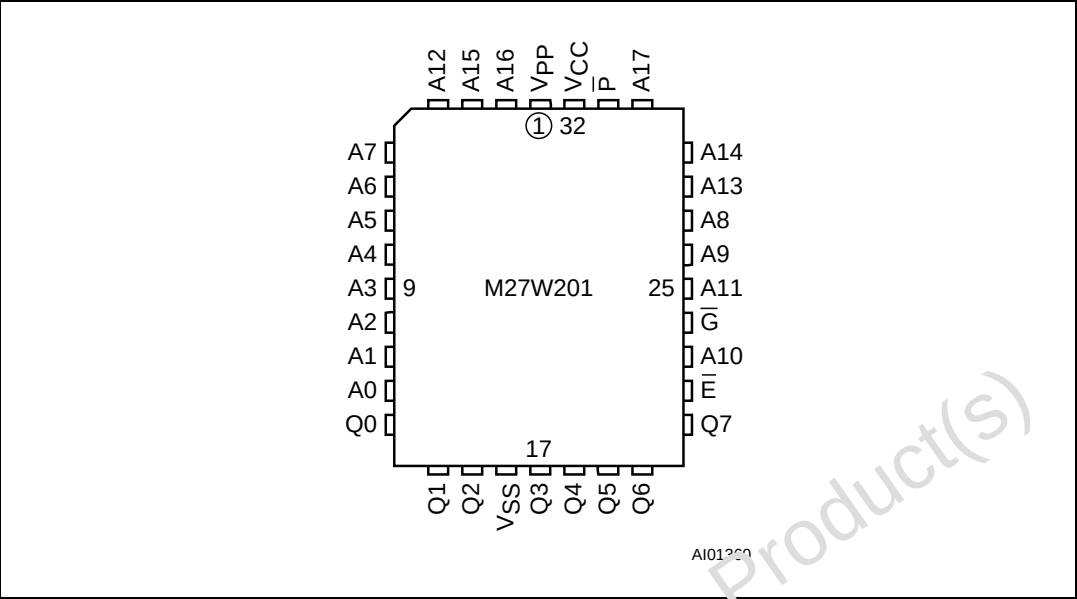
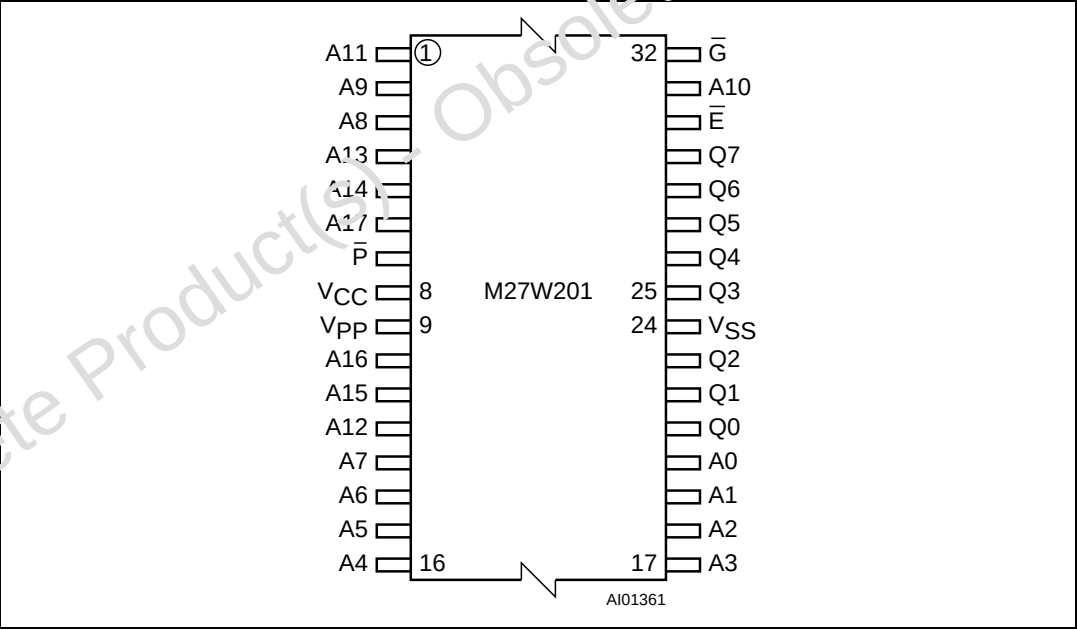


Figure 4. TSOP Connections



2 Device Description

The operating modes of the M27W201 are listed in the Operating Modes table. A single power supply is required in the read mode. All inputs are TTL levels except for V_{PP} and 12V on A9 for Electronic Signature.

Table 1. Operating Modes

Table 2. Operating modes

Mode	$\bar{E}$	$\bar{G}$	$\bar{P}$	A9	V_{PP}	Q7-Q0
Read	V_{IL}	V_{IL}	X	X	V_{CC} or V_{SS}	Data Out
Output Disable	V_{IL}	V_{IH}	X	X	V_{CC} or V_{SS}	Hi-Z
Program	V_{IL}	V_{IH}	V_{IL} Pulse	X	V_{PP}	Data In
Verify	V_{IL}	V_{IL}	V_{IH}	X	V_{PP}	Data Out
Program Inhibit	V_{IH}	X	X	X	V_{PP}	Hi-Z
Standby	V_{IH}	X	X	X	V_{CC} or V_{SS}	Hi-Z
Electronic Signature	V_{IL}	V_{IL}	V_{IH}	V_{ID}	V_{CC}	Codes

Note: $X = V_{IH}$ or V_{IL} , $V_{ID} = 12V \pm 0.5V$.

2.1 Read mode

The M27W201 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable ($\bar{E}$) is the power control and should be used for device selection. Output Enable ($\bar{G}$) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that the addresses are stable, the address access time (t_{AVQV}) is equal to the delay from $\bar{E}$ to output (t_{ELQV}). Data is available at the output after a delay of t_{GLQV} from the falling edge of $\bar{G}$, assuming that $\bar{E}$ has been low and the addresses have been stable for at least $t_{AVQV} - t_{GLQV}$.

2.2 Standby mode

The M27W201 has a standby mode which reduces the supply current from 15mA to 15μA with low voltage operation $V_{CC} \leq 3.6V$, see Read Mode DC Characteristics table for details. The M27W201 is placed in the standby mode by applying a CMOS high signal to the $\bar{E}$ input. When in the standby mode, the outputs are in a high impedance state, independent of the $\bar{G}$ input.

2.3 Two-line output control

Because EPROMs are usually used in larger memory arrays, this product features a 2-line control function which accommodates the use of multiple memory connection. The two line control function allows:

- the lowest possible memory power dissipation,
- complete assurance that output bus contention will not occur.

For the most efficient use of these two control lines, $\overline{E}$ should be decoded and used as the primary device selecting function, while $\overline{G}$ should be made a common connection to all devices in the array and connected to the $\overline{READ}$ line from the system control bus. This ensures that all deselected memory devices are in their low power standby mode and that the output pins are only active when data is required from a particular memory device.

2.4 System considerations

The power switching characteristics of Advanced CMOS EPROMs require careful decoupling of the devices. The supply current, I_{CC} , has three segments that are of interest to the system designer: the standby current level, the active current level, and transient current peaks that are produced by the falling and rising edges of $\overline{E}$. The magnitude of the transient current peaks is dependent on the capacitive and inductive loading of the device at the output.

The associated transient voltage peaks can be suppressed by complying with the two line output control and by properly selected decoupling capacitors. It is recommended that a 0.1 μ F ceramic capacitor be used on every device between V_{CC} and V_{SS} . This should be a high frequency capacitor of low inherent inductance and should be placed as close to the device as possible. In addition, a 4.7 μ F bulk electrolytic capacitor should be used between V_{CC} and V_{SS} for every eight devices. The bulk capacitor should be located near the power supply connection point. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of PCB traces.

2.5 Programming

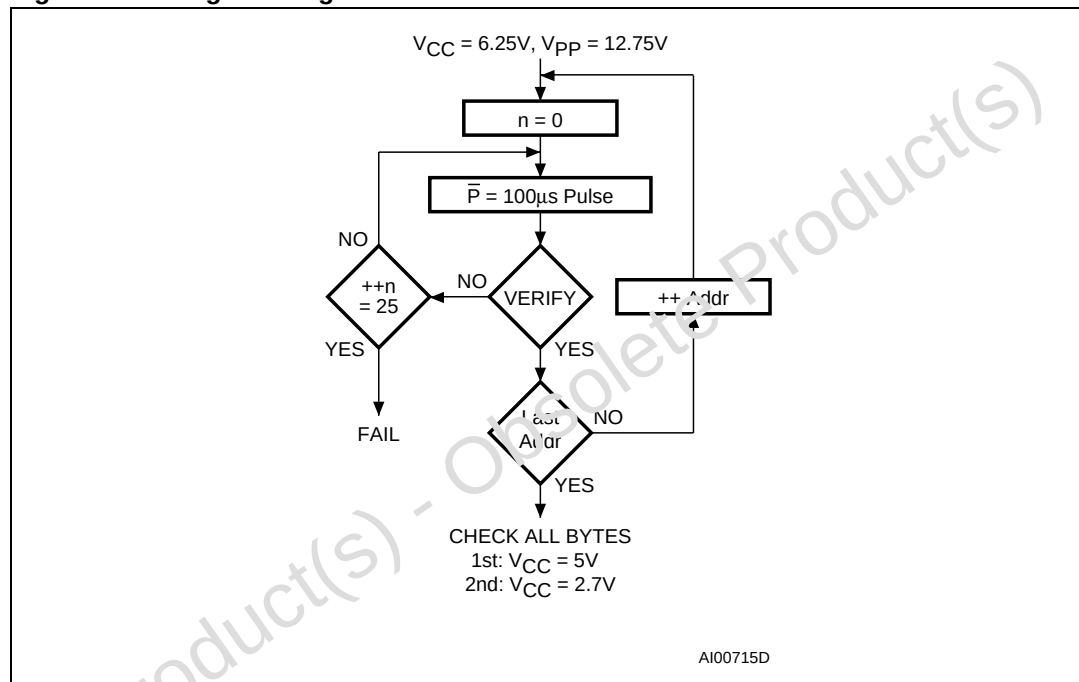
The M27W201 has been designed to be fully compatible with the M27C2001 and has the same electronic signature. As a result the M27W201 can be programmed as the M27C2001 on the same programming equipment applying 12.75V on V_{PP} and 6.25V on V_{CC} by the use of the same PRESTO II algorithm.

When delivered (and after each '1's erasure for UV EPROM), all bits of the M27W201 are in the '1' state. Data is introduced by selectively programming '0's into the desired bit locations. Although only '0's will be programmed, both '1's and '0's can be present in the data word. The only way to change a '0' to a '1' is by die exposure to ultraviolet light (UV EPROM). The M27W201 is in the programming mode when V_{PP} input is at 12.75V, $\overline{E}$ is at V_{IL} and $\overline{P}$ is pulsed to V_{IL} . The data to be programmed is applied to 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL. V_{CC} is specified to be 6.25V $\pm$ 0.25V.

2.6 Presto II programming algorithm

Presto II Programming Algorithm allows the whole array to be programmed with a guaranteed margin, in a typical time of 26.5 seconds. Programming with Presto II consists of applying a sequence of 100 μ s program pulses to each byte until a correct verify occurs (see [Figure 5](#)). During programming and verify operation, a Margin mode circuit is automatically activated in order to guarantee that each cell is programmed with enough margin. No overprogram pulse is applied since the verify in Margin mode at V_{CC} much higher than 3.6V, provides the necessary margin to each programmed cell.

Figure 5. Programming flowchart



2.7 Program Inhibit

Programming of multiple M27W201s in parallel with different data is also easily accomplished. Except for $\bar{E}$, all like inputs including $\bar{G}$ of the parallel M27W201 may be common. A TTL low level pulse applied to a M27W201's P input, with $\bar{E}$ low and V_{PP} at 12.75V, will program that M27W201. A high level $\bar{E}$ input inhibits the other M27W201s from being programmed.

2.8 Program Verify

A verify (read) should be performed on the programmed bits to determine that they were correctly programmed. The verify is accomplished with $\bar{E}$ and $\bar{G}$ at V_{IL} , $\bar{P}$ at V_{IH} , V_{PP} at 12.75V and V_{CC} at 6.25V.

2.9 Electronic Signature

The Electronic Signature (ES) mode allows the reading out of a binary code from an EPROM that will identify its manufacturer and type. This mode is intended for use by programming equipment to automatically match the device to be programmed with its corresponding programming algorithm. The ES mode is functional in the $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ ambient temperature range that is required when programming the M27W201. To activate the ES mode, the programming equipment must force 11.5V to 12.5V on address line A9 of the M27W201 with $V_{PP} = V_{CC} = 5\text{V}$. Two identifier bytes may then be sequenced from the device outputs by toggling address line A0 from V_{IL} to V_{IH} . All other address lines must be held at V_{IL} during Electronic Signature mode. Byte 0 ($A0 = V_{IL}$) represents the manufacturer code and byte 1 ($A0 = V_{IH}$) the device identifier code. For the STMicroelectronics M27W201, these two identifier bytes are given in [Table 3](#) and can be read-out on outputs Q7 to Q0. Note that the M27W201 and M27C2001 have the same identifier byte.

Table 3. Electronic Signature

Identifier	A0	Q7	Q6	Q5	Q4	Q3	Q2	Q1	Q0	Hex Data
Manufacturer's Code	V_{IL}	0	0	1	0	0	0	0	0	20h
Device Code	V_{IH}	0	1	1	0	0	0	0	1	61h

2.10 Erasure operation (applies to UV EPROM)

The erasure characteristics of the M27W201 are such that erasure begins when the cells are exposed to light with wavelengths shorter than approximately 4000 Å. It should be noted that sunlight and some type of fluorescent lamps have wavelengths in the 3000-4000 Å range. Data shows that constant exposure to room level fluorescent lighting could erase a typical M27W201 in about 3 years, while it would take approximately 1 week to cause erasure when exposed to direct sunlight. If the M27W201 is to be exposed to these types of lighting conditions for extended periods of time, it is suggested that opaque labels be put over the M27W201 window to prevent unintentional erasure. The recommended erasure procedure for the M27W201 is exposure to short wave ultraviolet light which has wavelength of 2537 Å. The integrated dose (i.e. UV intensity x exposure time) for erasure should be a minimum of 15 W-sec/cm². The erasure time with this dosage is approximately 15 to 20 minutes using an ultraviolet lamp with 12000 µW/cm² power rating. The M27W201 should be placed within 2.5 cm (1 inch) of the lamp tubes during the erasure. Some lamps have a filter on their tubes which should be removed before erasure.

3 Maximum ratings

Table 4. Absolute Maximum Ratings ⁽¹⁾

Symbol	Parameter	Value	Unit
T_A	Ambient Operating Temperature ⁽²⁾	–40 to 125	°C
T_{BIAS}	Temperature Under Bias	–50 to 125	°C
T_{STG}	Storage Temperature	–65 to 150	°C
V_{IO} ⁽³⁾	Input or Output Voltage (except A9)	–2 to 7	V
V_{CC}	Supply Voltage	–2 to 7	V
V_{A9} ⁽³⁾	A9 Voltage	–2 to 13.5	V
V_{PP}	Program Supply Voltage	–2 to 14	V

1. Except for the rating "Operating Temperature Range", stresses above those listed in the Table "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.
2. Depends on range.
3. Minimum DC voltage on Input or Output is –0.5V with possible undershoot to –2.0V for a period less than 20ns. Maximum DC voltage on Output is VCC +0.5V with possible overshoot to VCC +2V for a period less than 20ns.

4 DC and AC parameters

$T_A = -40$ to 85°C ; $V_{CC} = 2.7\text{V}$ to 3.6V ; $V_{PP} = V_{CC}$

Table 5. Read Mode DC Characteristics ⁽¹⁾

Symbol	Parameter	Test Condition	Min.	Max.	Unit
I_{LI}	Input Leakage Current	$0\text{V} \leq V_{IN} \leq V_{CC}$		± 10	μA
I_{LO}	Output Leakage Current	$0\text{V} \leq V_{OUT} \leq V_{CC}$		± 10	μA
I_{CC}	Supply Current	$\bar{E} = V_{IL}, \bar{G} = V_{IL}, I_{OUT} = 0\text{mA},$ $f = 5\text{MHz}, V_{CC} \leq 3.6\text{V}$		15	mA
I_{CC1}	Supply Current (Standby) TTL	$\bar{E} = V_{IH}$		1	nA
I_{CC2}	Supply Current (Standby) CMOS	$\bar{E} > V_{CC} - 0.2\text{V}, V_{CC} \leq 3.6\text{V}$		15	μA
I_{PP}	Program Current	$V_{PP} = V_{CC}$		10	μA
V_{IL}	Input Low Voltage		-0.3	$0.2V_{CC}$	V
$V_{IH}^{(2)}$	Input High Voltage		$0.7V_{CC}$	$V_{CC} + 0.5$	V
V_{OL}	Output Low Voltage	$I_{OL} = 2.1\text{mA}$		0.4	V
V_{OH}	Output High Voltage TTL	$I_{OH} = -400\mu\text{A}$	2.4		V

- V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP} .
- Maximum DC voltage on Output is $V_{CC} + 0.5\text{V}$.

$T_A = 25^\circ\text{C}$; $V_{CC} = 6.25\text{V} \pm 0.25\text{V}$; $V_{PP} = 12.75\text{V} \pm 0.25\text{V}$

Table 6. Programming Mode DC Characteristics ⁽¹⁾

Symbol	Parameter	Test Condition	Min	Max	Unit
I_{LI}	Input Leakage Current	$0 \leq V_{IN} \leq V_{CC}$		± 10	μA
I_{CC}	Supply Current			50	mA
I_{PP}	Program Current	$\bar{E} = V_{IL}$		50	mA
V_{IL}	Input Low Voltage		-0.3	0.8	V
V_{IH}	Input High Voltage		2.0	$V_{CC} + 0.5$	V
V_{OL}	Output Low Voltage	$I_{OL} = 2.1\text{mA}$		0.4	V
V_{OH}	Output High Voltage TTL	$I_{OH} = -400\mu\text{A}$	2.4		V
V_{ID}	A9 Voltage		11.5	12.5	V

- V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP} .

Table 7. AC Measurement Conditions

Parameter	High Speed	Standard
Input Rise and Fall Times	$\leq 10\text{ns}$	$\leq 20\text{ns}$
Input Pulse Voltages	0 to 3V	0.4V to 2.4V
Input and Output Timing Ref. Voltages	1.5V	0.8V and 2V

$T_A = 25^\circ\text{C}$, $f = 1\text{ MHz}$

Table 8. Capacitance ⁽¹⁾

Symbol	Parameter	Test Condition	Min.	Max.	Unit
C_{IN}	Input Capacitance	$V_{IN} = 0\text{V}$		6	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0\text{V}$		12	pF

1. Sampled only, not 100% tested.

Figure 6. AC Testing Input Output Waveform

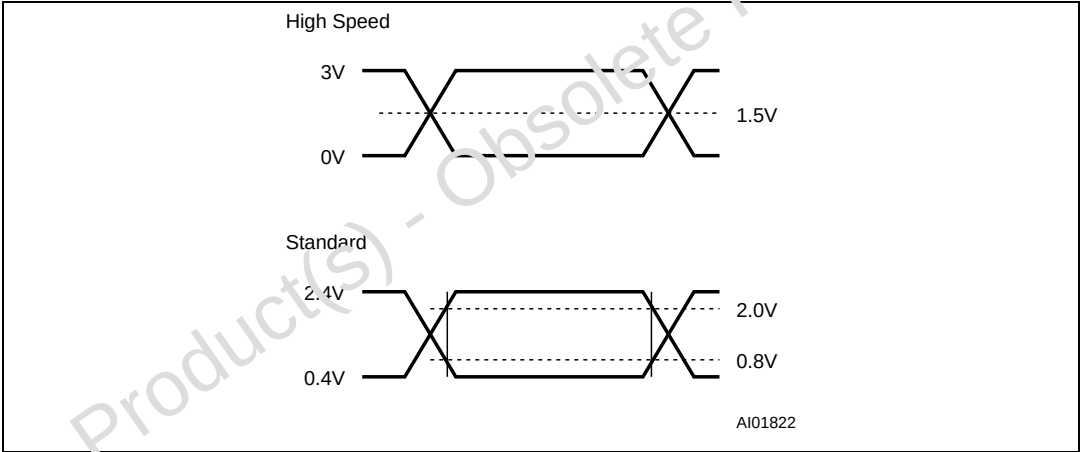
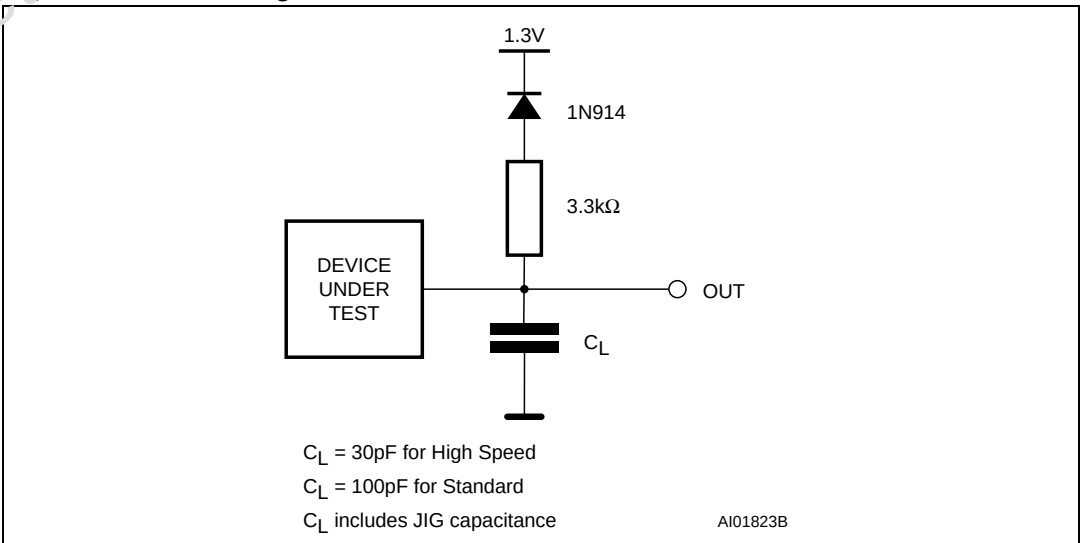


Figure 7. AC Testing Load Circuit



$T_A = -40$ to $85\text{ }^{\circ}\text{C}$; $V_{CC} = 2.7\text{V}$ to 3.6V ; $V_{PP} = V_{CC}$

Table 9. Read Mode AC Characteristics (1)

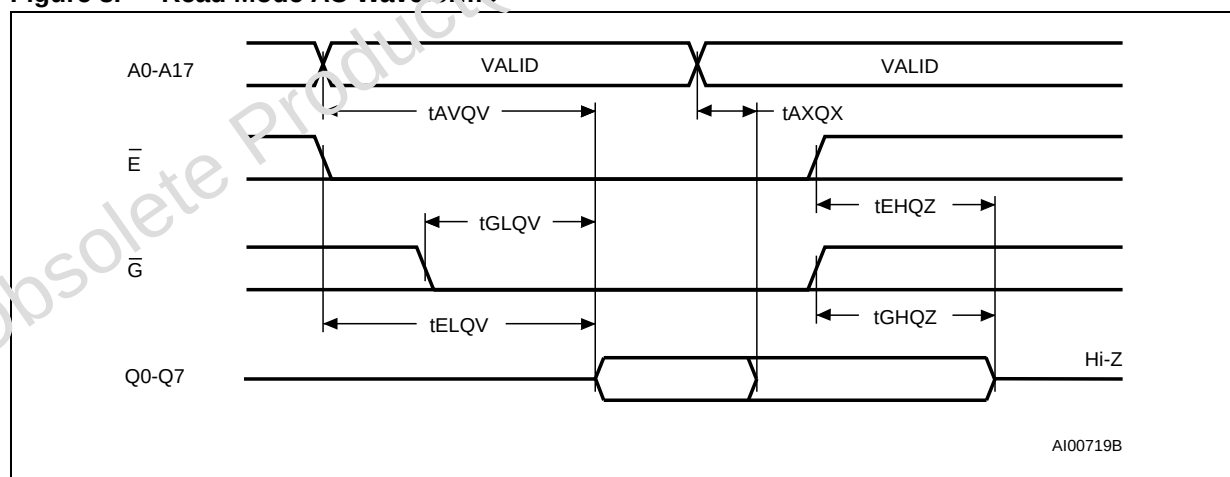
Symbol	Alt	Parameter	Test Condition	-80 (2)				-100 (-120/-150/-200)		Unit
				V _{CC} = 3.0V to 3.6V		V _{CC} = 2.7V to 3.6V		V _{CC} = 2.7V to 3.6V		
				Min.	Max.	Min.	Max.	Min.	Max.	
t _{AVQV}	t _{ACC}	Address Valid to Output Valid	$\overline{E} = V_{IL}, \overline{G} = V_{IL}$		70		80		100	ns
t _{ELQV}	t _{CE}	Chip Enable Low to Output Valid	$\overline{G} = V_{IL}$		70		80		100	ns
t _{GLQV}	t _{OE}	Output Enable Low to Output Valid	$\overline{E} = V_{IL}$		40		50		60	ns
t _{EHQZ} (3)	t _{DF}	Chip Enable High to Output Hi-Z	$\overline{G} = V_{IL}$	0	40	0	50	0	60	ns
t _{GHQZ} (3)	t _{DF}	Output Enable High to Output Hi-Z	$\overline{E} = V_{IL}$	0	40	0	50	0	60	ns
t _{AXQX}	t _{OH}	Address Transition to Output Transition	$\overline{E} = V_{IL}, \overline{G} = V_{IL}$	0		0		0		ns

1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP} .

2. Speed obtained with High Speed AC measurement conditions.

3. Sampled only, not 100% tested.

Figure 8. Read Mode AC Waveforms



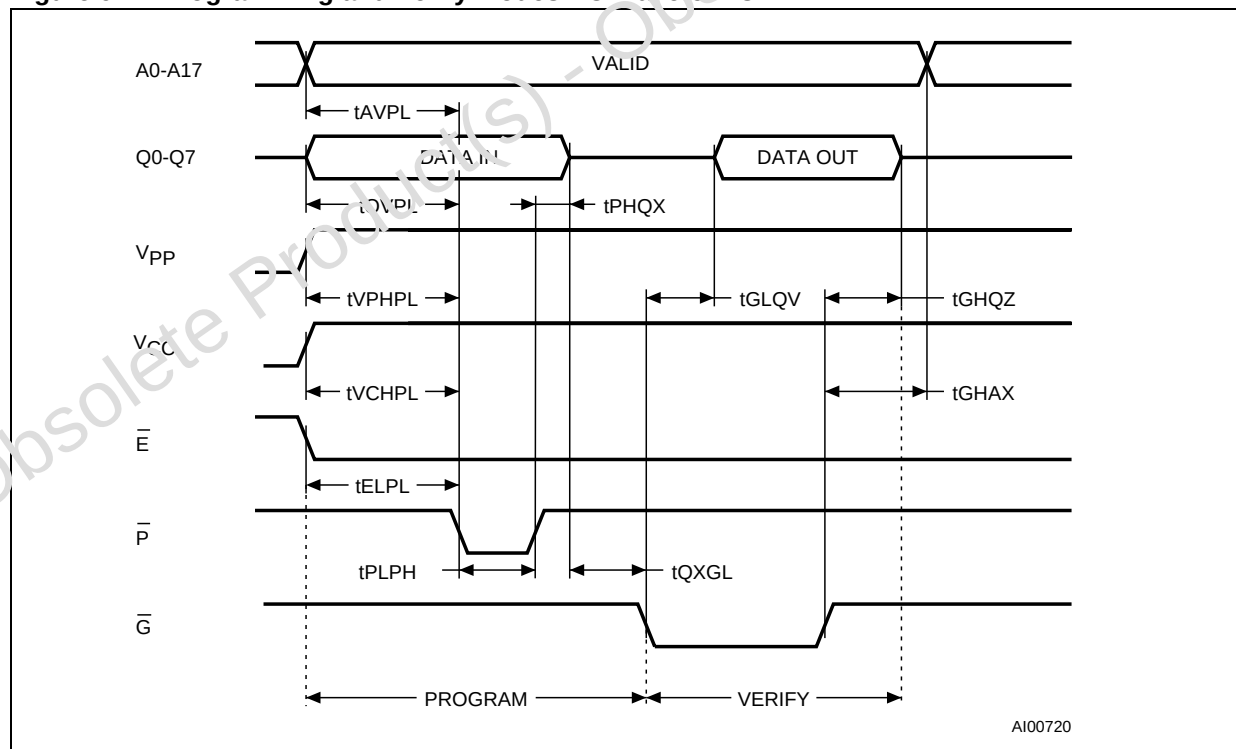
$$T_A = 25\text{ }^{\circ}\text{C}; V_{CC} = 6.25\text{V} \pm 0.25\text{V}; V_{PP} = 12.75\text{V} \pm 0.25\text{V}$$

Table 10. Programming Mode AC Characteristics ⁽¹⁾

Symbol	Alt	Parameter	Test Condition	Min.	Max.	Unit
t_{AVPL}	t_{AS}	Address Valid to Program Low		2		μs
t_{QVPL}	t_{DS}	Input Valid to Program Low		2		μs
t_{VPHPL}	t_{VPS}	V_{PP} High to Program Low		2		μs
t_{VCHPL}	t_{VCS}	V_{CC} High to Program Low		2		μs
t_{ELPL}	t_{CES}	Chip Enable Low to Program Low		2		μs
t_{PLPH}	t_{PW}	Program Pulse Width		95	105	μs
t_{PHQX}	t_{DH}	Program High to Input Transition		2		μs
t_{QXGL}	t_{OES}	Input Transition to Output Enable Low		2		μs
t_{GLQV}	t_{OE}	Output Enable Low to Output Valid			100	ns
$t_{GHQZ}^{(2)}$	t_{DFP}	Output Enable High to Output Hi-Z		0	130	ns
t_{GHAX}	t_{AH}	Output Enable High to Address Transition		0		ns

1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously or after V_{PP} .

2. Sampled only, not 100% tested.

Figure 9. Programming and Verify Modes AC Waveforms

5 Package mechanical data

5.1 32-pin Ceramic Frit-seal DIP, with round window (FDIP32WA)

Figure 10. FDIP32WA package outline

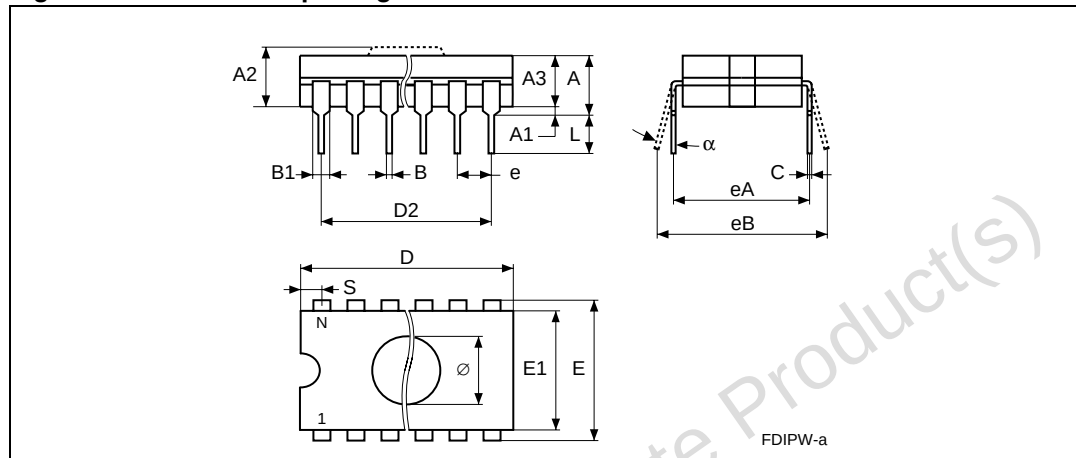


Table 11. FDIP32WA package mechanical data

Symbol	millimeters			inches		
	Min	Typ	Max	Min	Typ	Max
A			5.72			0.225
A1	0.51		1.40	0.020		0.055
A2	3.91		4.57	0.154		0.180
A3	3.29		4.50	0.153		0.177
B	0.41		0.56	0.016		0.022
B1		1.45			0.057	
C	0.23		0.30	0.009		0.012
D	41.73		42.04	1.643		1.655
D2		38.10			1.500	
e		2.54			0.100	
E		15.24			0.600	
E1	13.06		13.36	0.514		0.526
eA		14.99			0.590	
eB	16.18		18.03	0.637		0.710
L	3.18		4.10	0.125		0.161
N		32			32	
S	1.52		2.49	0.060		0.098
Ø		7.11			0.280	
α	4°		11°	4°		11°

5.2 32-pin Plastic DIP, 600 mils width (PDIP32)

Figure 11. PDIP32 package outline

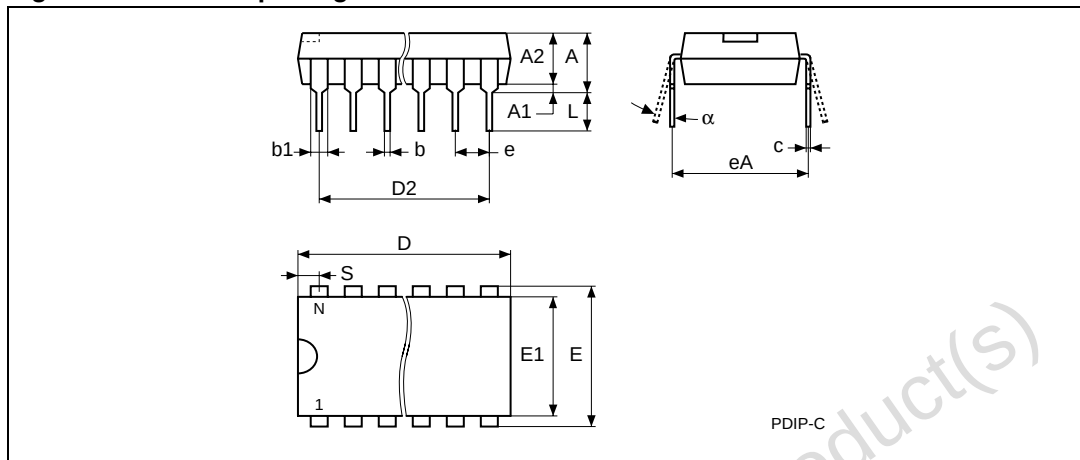


Table 12. PDIP32 package mechanical data

Symbol	millimeters			inches		
	Min	Typ	Max	Min	Typ	Max
A			4.93			0.190
A1	0.38			0.015		
A2		3.81			0.150	
b	0.41		0.53	0.016		0.021
b1	1.14		1.65	0.045		0.065
c	0.25		0.38	0.009		0.015
D	11.78		42.29	1.645		1.665
D2		38.10			1.500	
eA		15.24			0.600	
e		2.54			0.100	
E	15.24		15.88	0.600		0.625
E1	13.46		13.97	0.530		0.550
S	1.65		2.21	0.065		0.087
L	3.05		3.56	0.120		0.140
α	0°		15°	0°		15°
N		32			32	

5.3 32-lead Rectangular Plastic Leaded Chip Carrier (PLCC32)

Figure 12. PLCC32 package outline

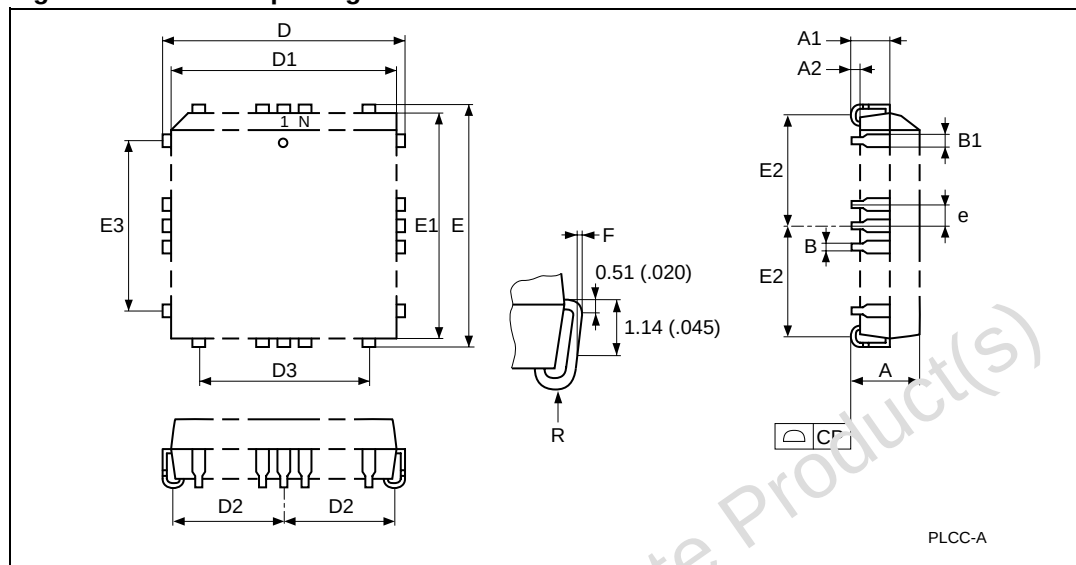


Table 13. PLCC32 package mechanical data

Symbol	millimeters			inches		
	Min	Typ	Max	Min	Typ	Max
A	3.18		3.56	0.125		0.140
A1	1.53		2.41	0.060		0.095
A2	0.38		—	0.015		—
B	0.33		0.53	0.013		0.021
B1	0.66		0.81	0.026		0.032
CP			0.10			0.004
D	12.32		12.57	0.485		0.495
D1	11.35		11.51	0.447		0.453
D2	4.78		5.66	0.188		0.223
D3		7.62			0.300	
E	14.86		15.11	0.585		0.595
E1	13.89		14.05	0.547		0.553
E2	6.05		6.93	0.238		0.273
E3		10.16			0.400	
e		1.27			0.050	
F	0.00		0.13	0.000		0.005
R		0.89			0.035	
N		32			32	

5.4 32-lead Plastic Thin Small Outline, 8 x 20 mm (TSOP32)

Figure 13. TSOP32 package outline

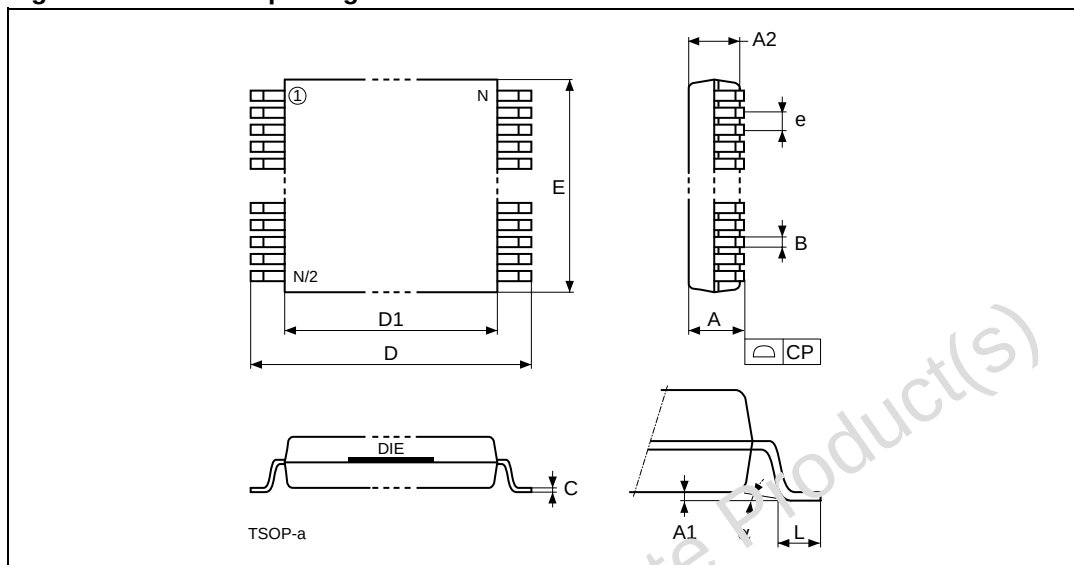


Table 14. TSOP32 package mechanical data

Symbol	millimeters			inches		
	Min	Typ	Max	Min	Typ	Max
A			1.200			0.0472
A1	0.050		0.150	0.0020		0.0059
A2	0.950		1.050	0.0374		0.0413
B	0.170		0.250	0.0067		0.0098
C	0.100		0.210	0.0039		0.0083
CP			0.100			0.0039
D	19.800		20.200	0.7795		0.7953
D1	18.300		18.500	0.7205		0.7283
e	–	0.500	–	–	0.0197	–
E	7.900		8.100	0.3110		0.3189
L	0.500		0.700	0.0197		0.0276
N		32			32	
α	0°		5°	0°		5°

5.5 32-lead Plastic Thin Small Outline, 8x 14 mm (TSOP32)

Figure 14. TSOP32 package outline

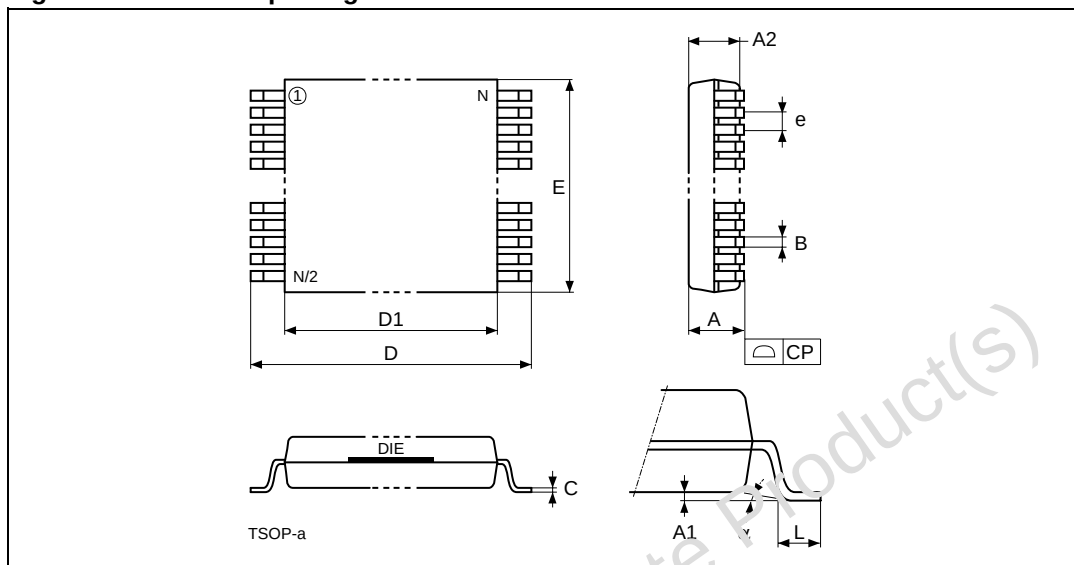


Table 15. TSOP32 package mechanical data

Symbol	millimeters			inches		
	Min	Typ	Max	Min	Typ	Max
A			1.200			0.0472
A1	0.050		0.150	0.0020		0.0059
A2	0.950		1.050	0.0374		0.0413
a	0		5	0		5
B	0.170		0.270	0.0067		0.0106
C	0.100		0.210	0.0039		0.0083
CP			0.100			0.0039
D	13.800		14.200	0.5433		0.5591
D1	12.300		12.500	0.4843		0.4921
e	–	0.500	–	–	0.0197	–
E	7.900		8.100	0.3110		0.3189
L	0.500		0.700	0.0197		0.0276
N		32			32	

6 Part numbering

Table 16. Ordering Information Scheme

Example:	M27W201	-80	K	6	TR
Device Type M27					
Supply Voltage W = 2.7V to 3.6V					
Device Function 201 = 2 Mbit (256Kb x 8)					
Speed -80 ⁽¹⁾ ⁽²⁾ = 80 ns -100 = 100 ns					
Not For New Design ⁽³⁾ -120 = 120 ns -150 = 150 ns -200 = 200 ns					
Package F = FDIP32W ⁽⁴⁾ B = PDIP32 K = PLCC32 N = TSOP32: 8 x 20 mm ⁽⁴⁾ NZ = TSOP32: 8 x 14 mm ⁽⁴⁾					
Temperature Range 6 = -40 to 85 °C					
Options TR = ECOPACK® package, Tape & Reel Packing					

1. High Speed, see AC Characteristics section for further information.
2. This speed also guarantees 70ns access time at $V_{CC} = 3.0V$ to 3.6V.
3. These speeds are replaced by the 100ns.
4. Packages option available on request. Please contact STMicroelectronics local Sales Office.

For a list of available options (speed, package, etc...) or for further information on any aspect of this device, please contact the STMicroelectronics Sales Office nearest to you.

7 Revision history

Table 17. Document revision history

Date	Revision	Changes
25-Jul-1999	1	First Issue
19-Apr-2000	2	FDIP32W Package Dimension, L Max added (Table 11) TSOP32 Package Dimension changed (Table 14) 0 to 70°C Temperature Range deleted, Programming Time changed
24-Oct-2001	3	TSOP32 8x14mm added
12-Apr-2006	4	Converted to new template. Added ECOPACK® information.

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